

Title (en)
CONTACT DEVICE

Title (de)
KONTAKTVORRICHTUNG

Title (fr)
DISPOSITIF DE CONTACT

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Application
EP 07703262 A 20070205

Priority

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Abstract (en)
[origin: WO2007090590A1] The invention relates to a contact device (10) having at least a first contact region (12) which is designed for electrical connection to an electric line (102), and having at least a second contact region (14) which is designed for electrical connection to a flexible printed circuit board (104) or some other contact medium which experiences damage from repeated soldering, in which the first contact region (12) and the second contact region (14) are electrically connected. The invention provides here that between the first contact region (12) and the second contact region (14) a third region (16) is provided which has a lower thermal conductivity per unit length than the thermal conductivity per unit length of the first contact region (12) and/or which is the thermal conductivity per unit length of the second contact region (14).

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